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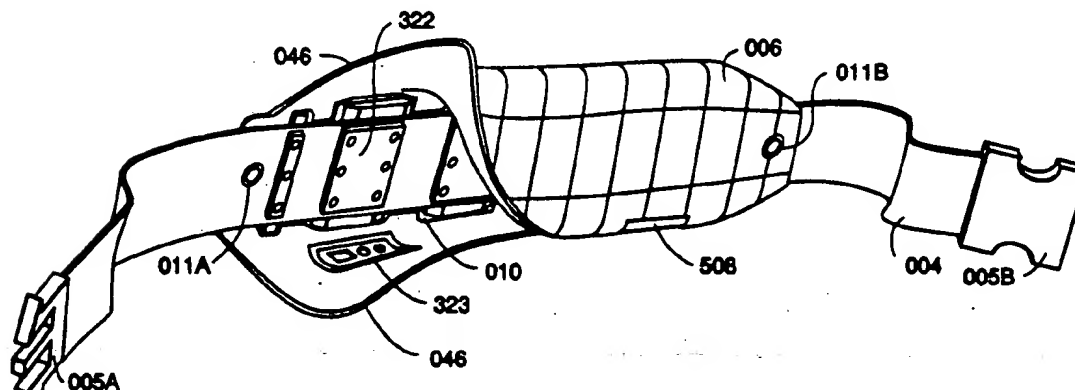
**United States Patent** [19]**Janik**[11] **Patent Number:** **5,285,398**[45] **Date of Patent:** **Feb. 8, 1994**[54] **FLEXIBLE WEARABLE COMPUTER**[75] **Inventor:** **Craig M. Janik, Palo Alto, Calif.**[73] **Assignee:** **Moblia Technology Inc., Palo Alto, Calif.**[21] **Appl. No.:** **884,117**[22] **Filed:** **May 15, 1992**[51] **Int. Cl.:** **G06F 1/00; H05K 5/00**[52] **U.S. Cl.:** **364/708.1; 361/680; 361/683; 361/730**[58] **Field of Search:** **364/708; 361/394, 398; 128/420.5, 421; 219/497**[56] **References Cited****U.S. PATENT DOCUMENTS**

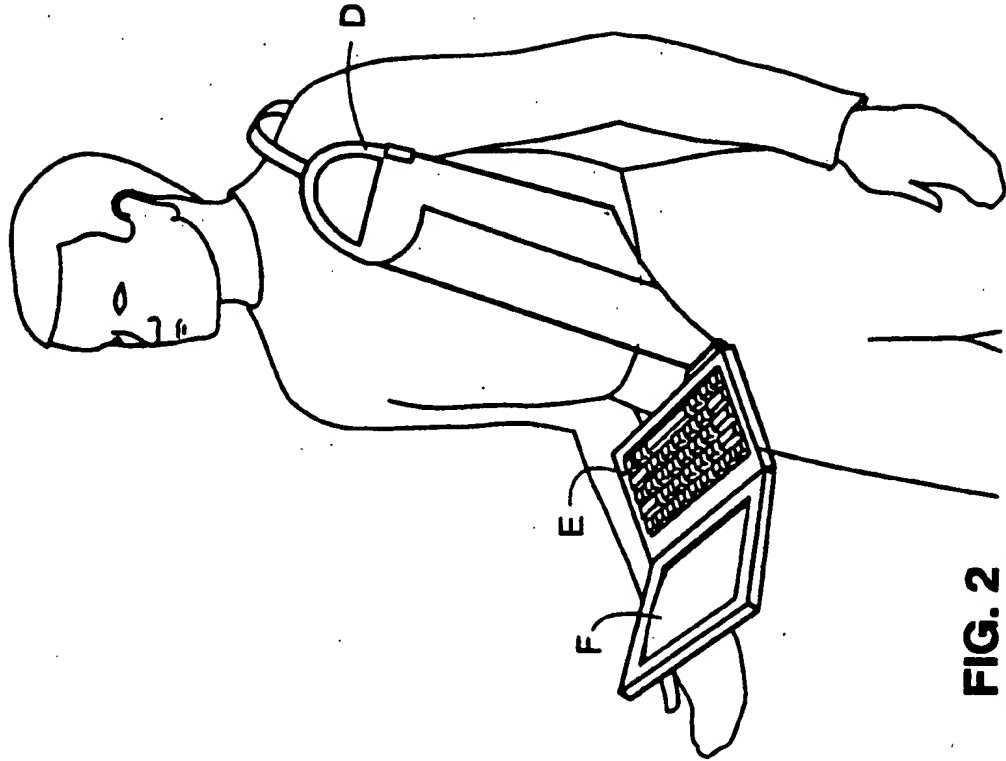
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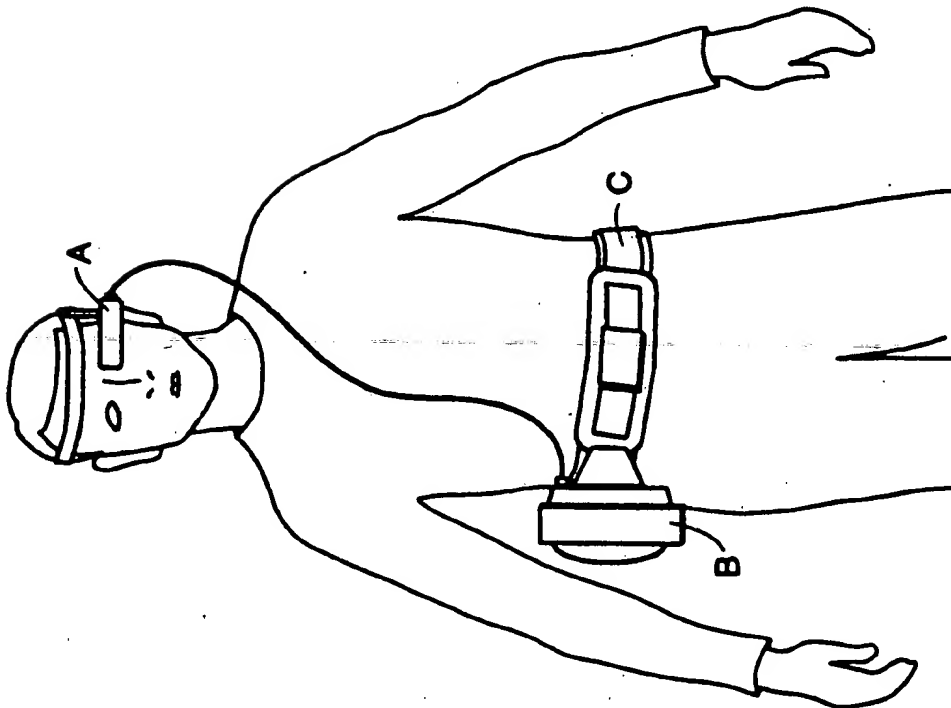
**Primary Examiner—Long T. Nguyen****Attorney, Agent, or Firm—Limbach & Limbach**[57] **ABSTRACT**

A flexible wearable computer in the form of a belt comprising in combination, elements for computing comprising a microprocessor module (200), a RAM-I/O module (300), a plurality of mass memory modules (400), a power supply module (500), and a plurality of bus termination modules (100) operationally associated with a plurality of flexible signal relaying circuit (002a, 002b, 002c, 002d, 002e, 002f). The computing elements are mechanically associated with a flexible nonstretchable member (004), and a protective covering device (006). The flexible nonstretchable wearable member (004) is secured around the waist by belt latches (005a, 005b). An input and output device (060) is connected to the flexible wearable computer by the I/O bus (061) attached to the output and input ports (326), and (327) respectively.

**20 Claims, 8 Drawing Sheets**



**FIG. 2**  
(PRIOR ART)



**FIG. 1**  
(PRIOR ART)

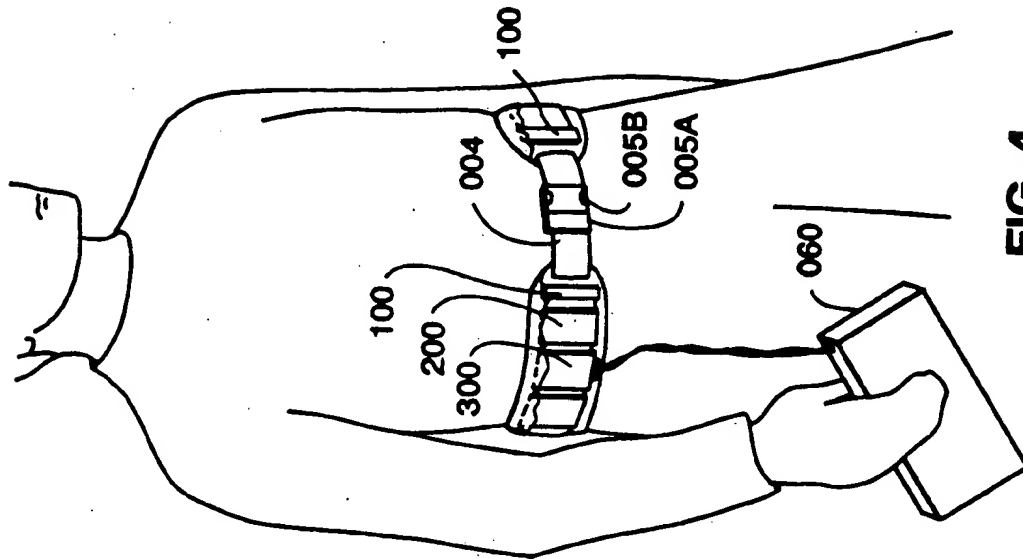


FIG. 4

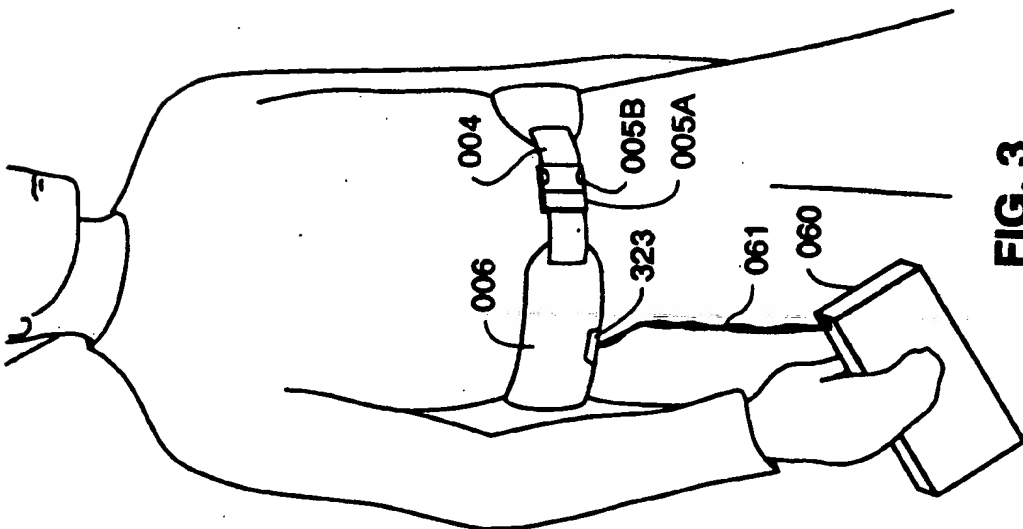
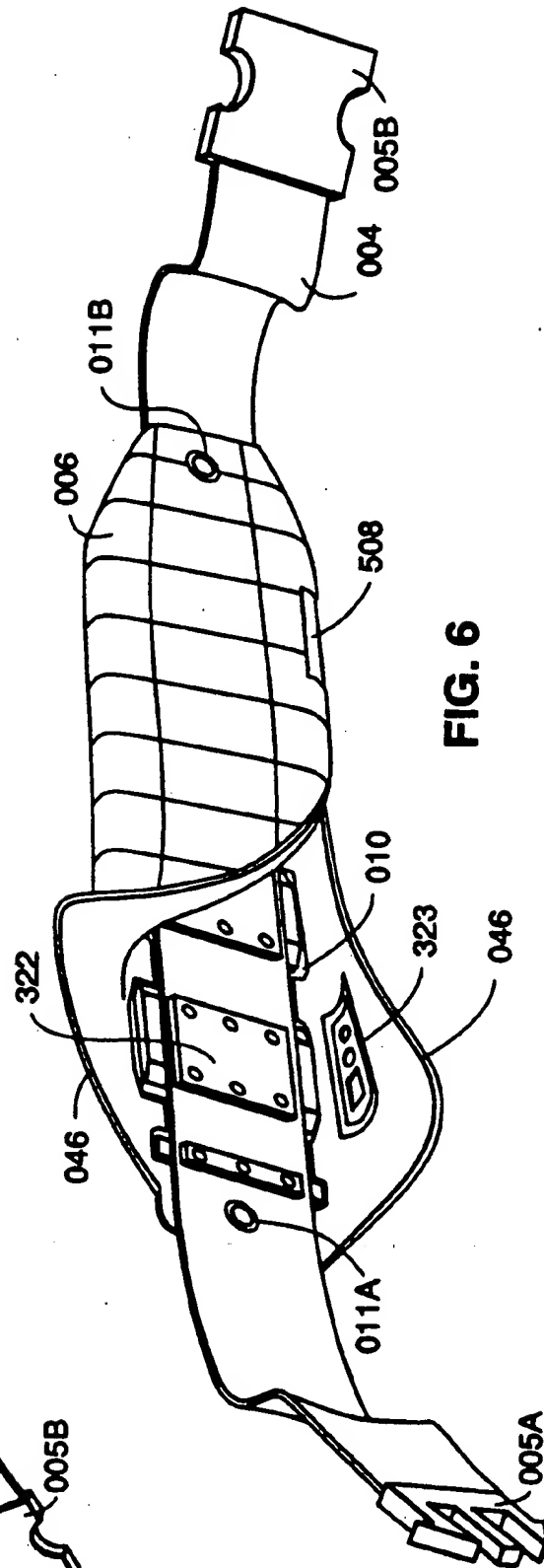
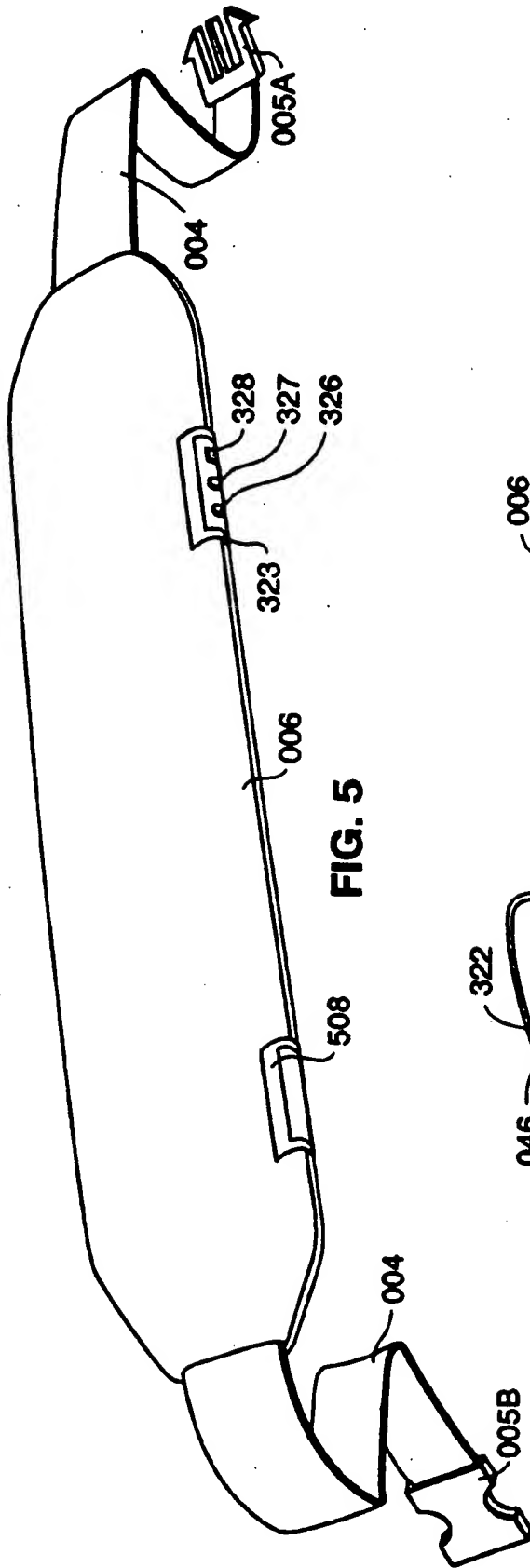
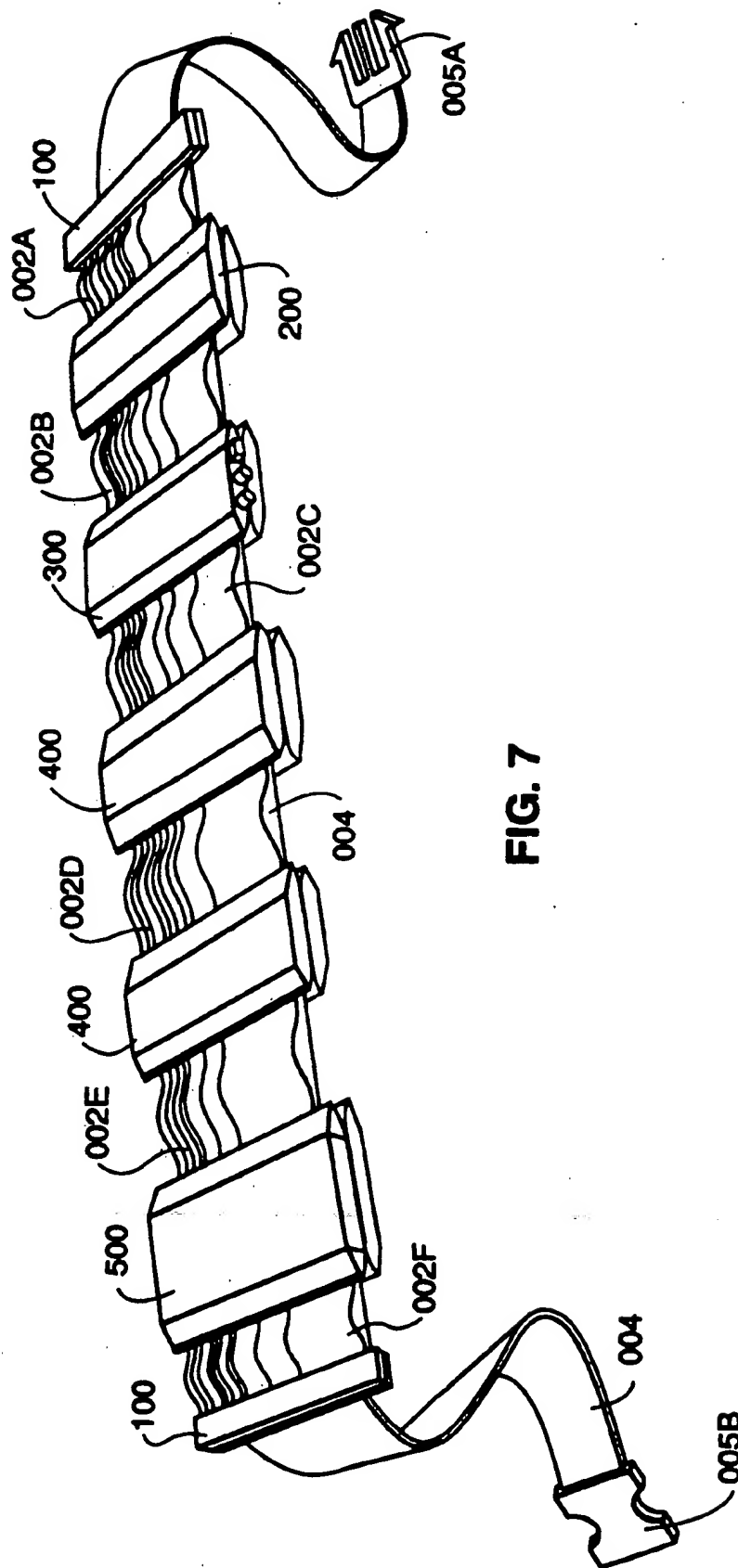
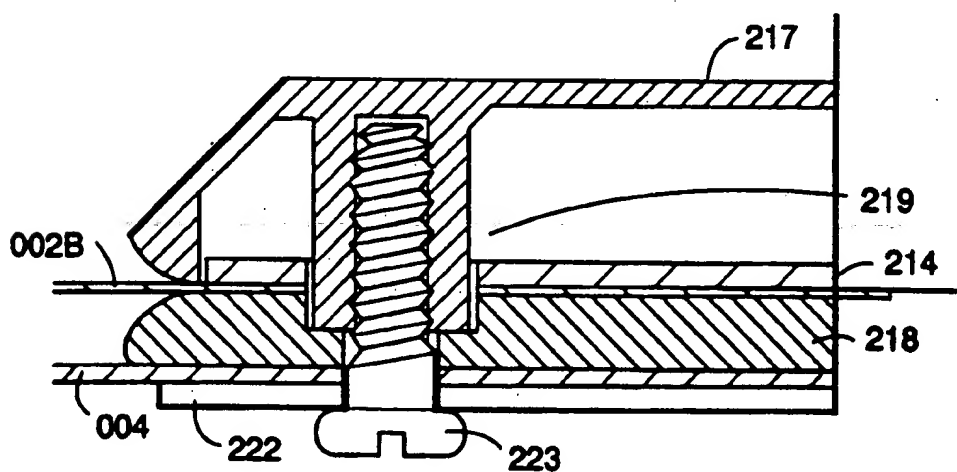
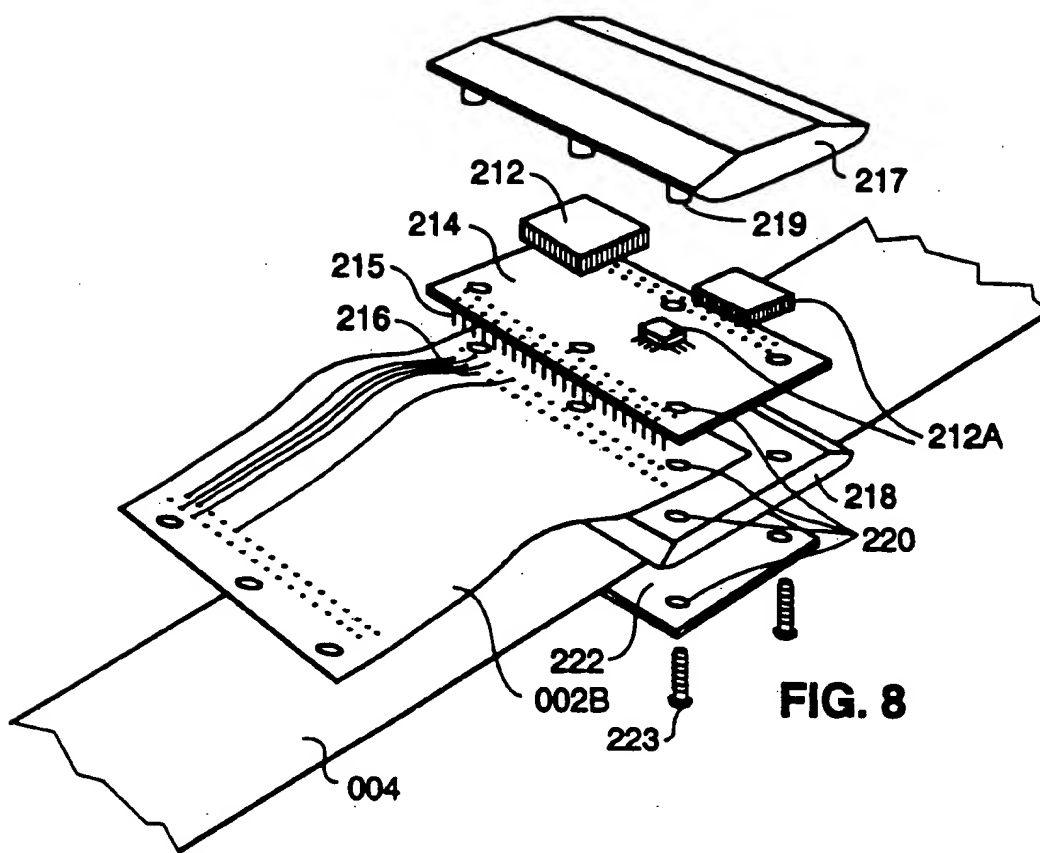
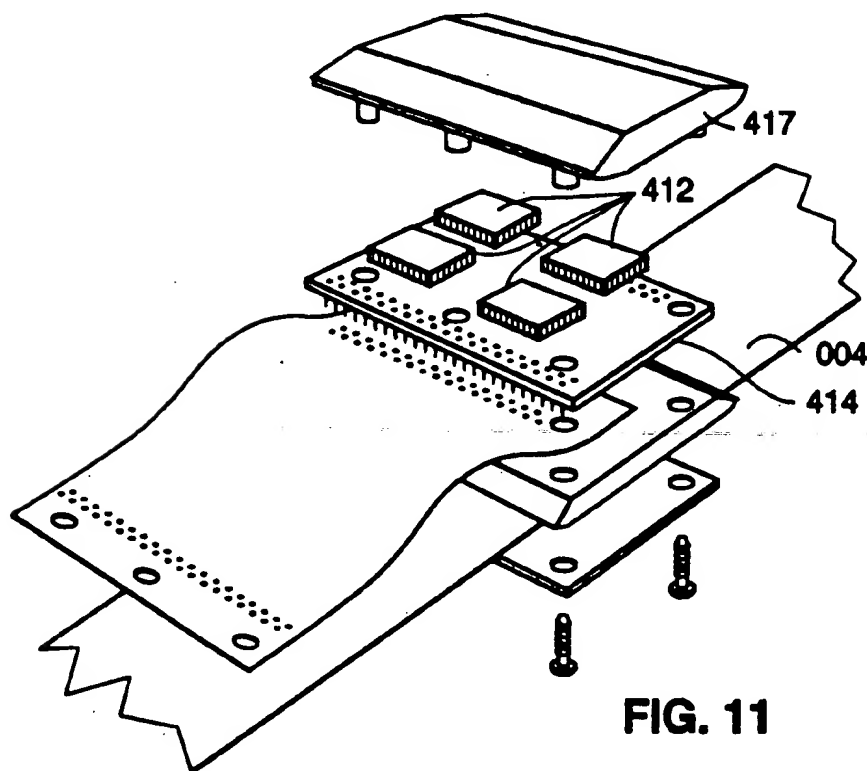
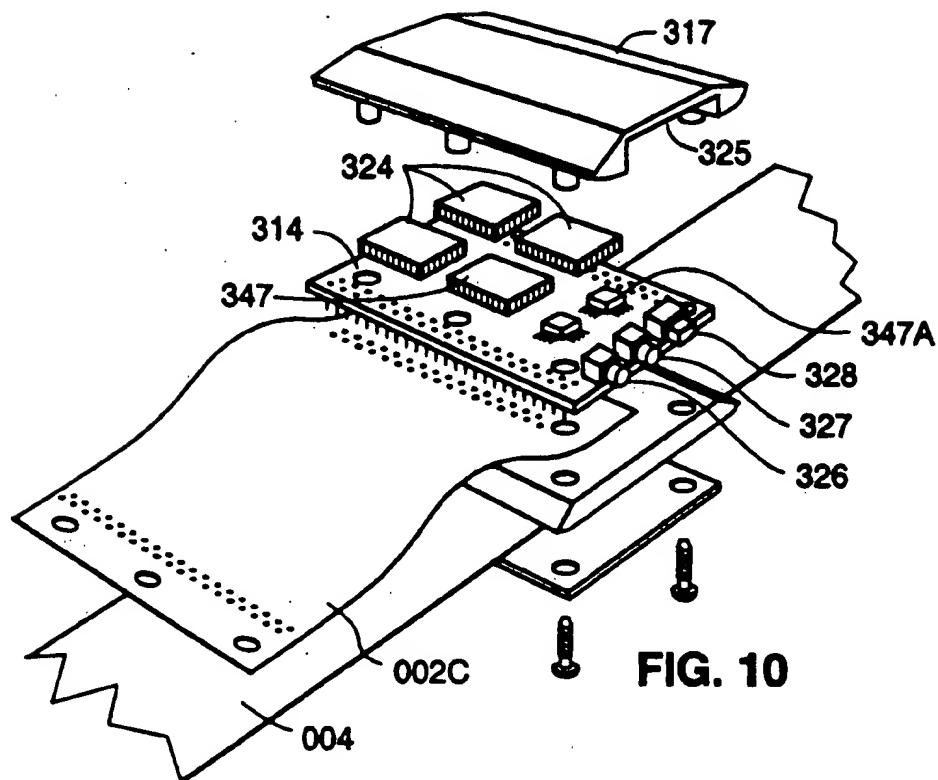


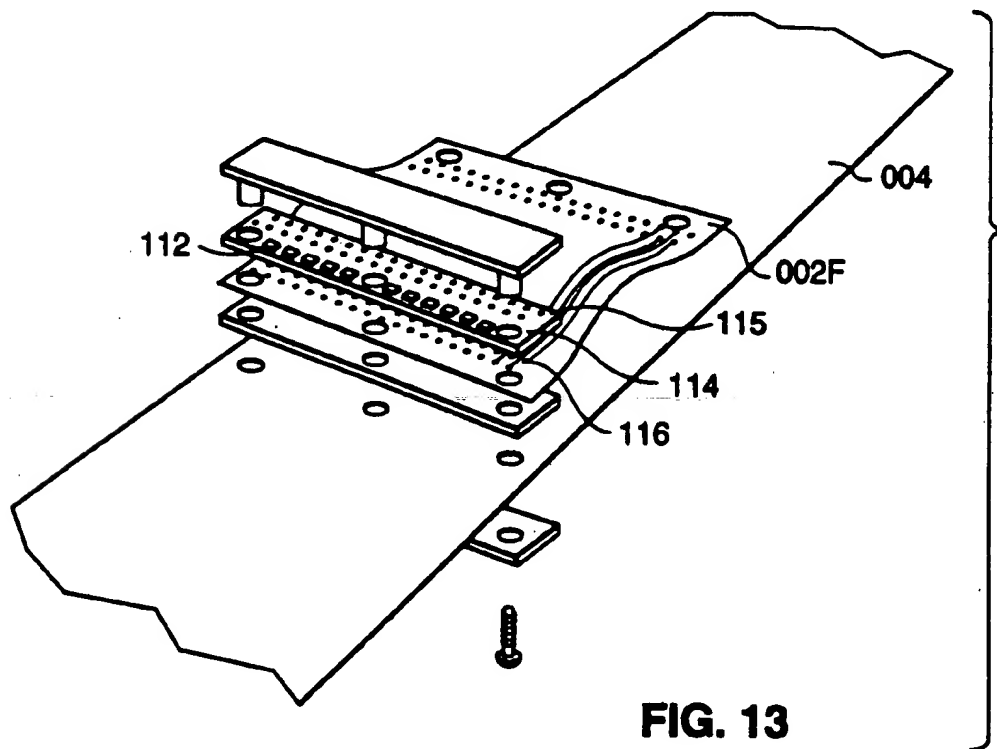
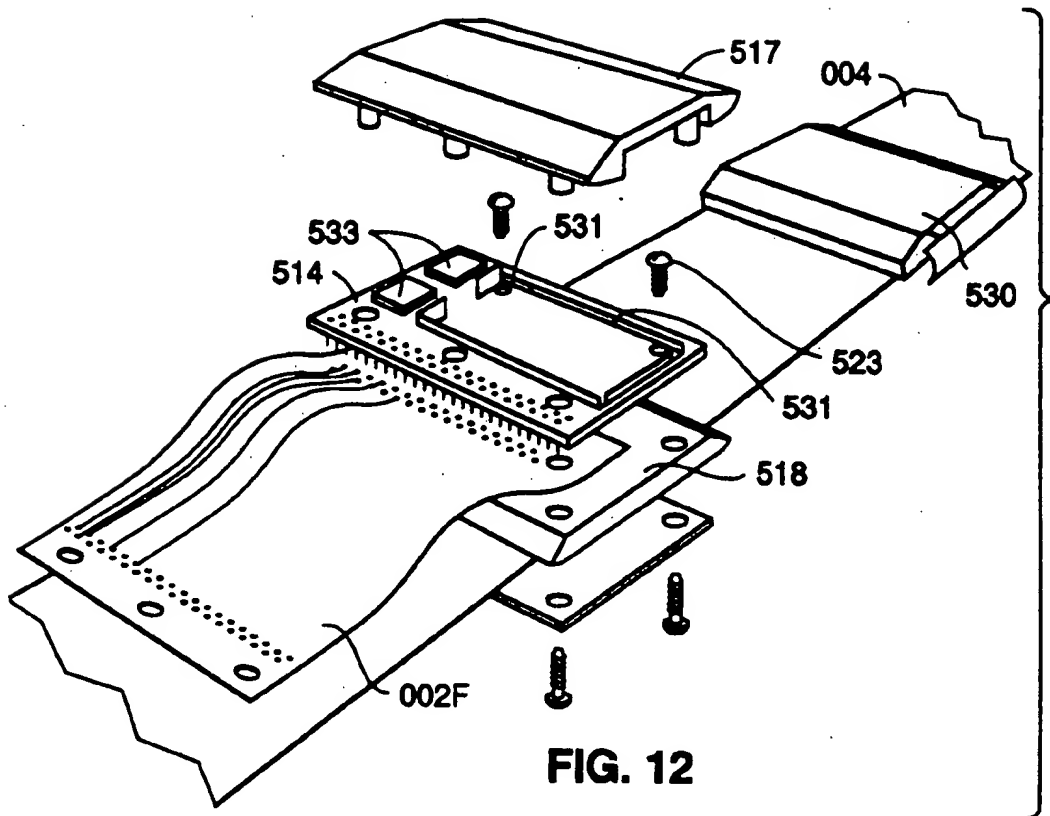
FIG. 3











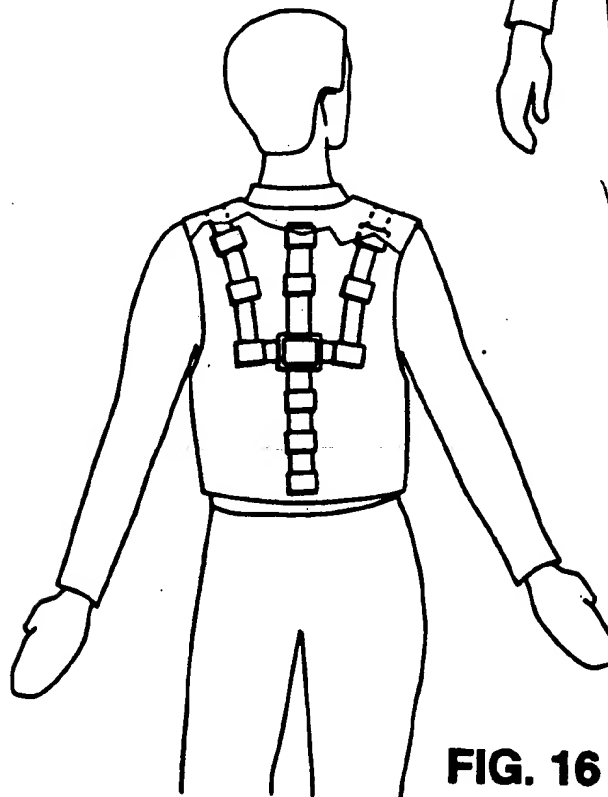




**FIG. 14**



**FIG. 15**



**FIG. 16**

## FLEXIBLE WEARABLE COMPUTER

### BACKGROUND-FIELD OF INVENTION

This invention relates generally to the field of portable computers, and more specifically to a flexible, wearable computer that can be worn on the body and repeatedly bent in an infinite number of planes without failure of operation.

### BACKGROUND-DESCRIPTION OF PRIOR ART

#### Definitions

A computer system is defined as comprising three basic components: an input device, an output device, and a computer. A computer is defined as comprising memory, a processor, and associated support circuitry and components. Memory comprises main memory which is volatile, and mass storage memory which is usually nonvolatile. A portable computer system is one that the user can easily carry around. Throughout this text the author will refer to a computer to mean only and specifically the main and secondary storage memory, the processor, and a power supply. The author will also use volume to characterize both the size and the mass of computers. This is because the overall density of silicon-based computers is asymptotic to a constant. Therefore, volume will necessarily indicate a maximum weight.

#### Integration

Small and therefore portable computers have resulted from the intersection of innovations and inventions across a wide variety of domains and fields including the arts of silicon manipulation, and mechanical and electrical design, and component integration. Integration is the process of decreasing the size of and the space between electrical elements, and it has been the pathway to power reduction and speed. But size reduction accrued benefits independent of processing power. Computers that once required buildings to house and small power plants to run can now be comfortably lifted with one hand. Since integration and therefore miniaturization has brought nearly all of the advances in service levels to date, it is the major force in the creation of the prior art in portable computing and the direction of future advancement for computer construction in general.

There has been tremendous innovation and invention using integration as a means of making computers portable. Computers are available that are small enough to be lifted by one finger. The result has been explosive demand for portable computing devices. Dataquest predicts that by 1994 sales of portable computing devices will be well over \$13 billion (Byte, volume 16, number 11, p194).

"Picocomputers" are the state of the art of integration as a means of creating portable computers (New York Times, Mar. 23, 1992). Inventors such as M. E. Jones, Jr. have developed a single chip that contain all of the elements needed for a computer. This has allowed creation of computer systems that can fit in the breast pocket of a man's jacket and run for 100 hours on a conventional flashlight battery. The major limitations of these computer systems is that they have very small amounts of memory greatly limiting the usefulness of the device for tasks to which most computer users are

accustomed. They also have very small input and output devices which are slow and inconvenient to use.

#### Useful Portables

Other innovations include computers with increased processing abilities that must be carried with one hand. These rigid rectilinear-shaped devices fall into the classes lap-top, palm-top or hand-held computers and increase the processing and memory capacity of the picocomputer by including the required processors and memory power in a larger enclosure. For the episodic portable computer user that spends little time actually carrying these devices, these rigid rectilinear devices provide high levels of service rivaling desk-top micro- and minicomputers. For the intensive user that processes large amounts of data and must also carry the computer for long periods time, these devices have several disadvantages.

First, research has shown that people carrying these computers for long periods of time are prone to flexi carpi ulnaris tendonitis which can be painful and debilitating. This affliction is due to prolonged and simultaneous clenching of the fingers and flexing of the wrist, an action unavoidable when carrying these devices.

Second, for intensive data acquisition applications, size once again is a constraint. The amount of secondary memory required for implementation makes this option impractical for portable computers in rigid rectilinear packaging. On-board memory requirements have been sidestepped by including wireless data links to a host computer for down-loading data. However, these options are very costly, up to the cost of the computer itself, and increase the volume of the devices by as much as a factor of two. Furthermore, wireless communication is presently a very slow data transfer process.

Third, field service research for Rockwell International has demonstrated that user compliance of rigid rectilinear hand-carried and hand-held computers is low, and gets lower as the size of the device increases. Field service personnel expressed considerable displeasure with having to lug a "brick" around during the execution of their task. Most notably it restricted the use of their hands by virtue of one, or both being used to carry the computer.

#### Wearable Portables

There has been innovation and invention to harness rigid rectilinear computers on various parts of the body. Reddy information Systems Inc. has produced a computer called Red Figure 1 that has a head mounted output device (A) from Reflection Technologies called the Private Eye, and a belt-mounted rigid rectilinear-packaged computer and input device (B) secured by a belt harness (C) (New York Times, Mar. 29, 1992). Infogrip Inc. and Select Tech Inc have combined technologies to produce the Hip PC in a similar configuration.

There are two main disadvantages to this approach. First, harnessing a rigid rectilinear-packaged computer anywhere on the body creates an uneven load on the spine. Prolonged wearing of such devices creates strain in the supporting muscles opposite the place where the computer is harnessed. Second, these configurations do not allow the human body to comfortably contact a firm surface. The rigid rectilinear computer on a harness or belt is literally a lump on the surface of the body. Lastly, rigid rectilinear designs are inherently limited in expandability. To increase processing power, hardware

size must be increased. There is a volume limit beyond which the computer is no longer portable.

There has been innovation and invention to make computers more comfortable to wear. Hideji Takemasa of NEC Corp has created a variety of rigid curvilinear-packaged computer models that conform to various parts of the body FIG. 2 (Fortune, Jan. 13, 1992). These devices include a processor and CD-ROM reader (D), and a fold out input/output device (E,F). Although aesthetically more appealing than the rigid rectilinear lumps of the Red and Hip PC models, the NEC models nonetheless suffer the same disadvantages. The NEC curvilinear designs are rigid and dynamically nonconforming and subject the spine to uneven loading. They also do not allow comfortable contact of the human body with firm surfaces. Furthermore, these rigid, curvilinear designs must be made in many sizes since it is technically impossible to make one of these designs fit all human morphologies. They are also inherently limited in expandability just as the rigid rectilinear designs.

### SUMMARY OF INVENTION

The present invention exemplifies a new and unobvious art of a flexible wearable computer. Briefly and generally, the flexible wearable computer comprises a microprocessor, memory, an input/output controller, and a power supply operably associated with one another through a flexible signal relaying means. The assembly is supported by a tensile load bearing means and protected by a compressive load bearing means. The microprocessor, memory, input/output controller, and power supply are mechanically associated in a module assembly such that the flexible wearable computer can bend in an infinite number of planes without failure of operation.

### OBJECTS AND ADVANTAGES

The most important advantage of the flexible wearable computer is that it will always provide greater utility than rigid designs for those users that must carry their computer around while processing large amounts of data, regardless of the state of the art of integration and miniaturization. That is, regardless of how much computer power can be delivered in a given rigid package, providing a flexible wearable computer allows more of that computer power to be comfortably carried by the user. For example, even if a Cray super computer can be reduced to the size of a wrist watch, the intensive computer user will find more utility in a flexible computer that is an array of the microprocessors in the wristwatch-sized Cray that is fashioned for instance as a comfortable vest.

This relationship can be mathematically demonstrated with a common market model adapted for computer power demand. Refer now to equation (1)

$$Q=c-aP+bS$$

(1)

where,

Q=total amount of computers demanded in a specified context;

P=the price of computers sold in the marketplace for that context;

S=the service level provided by computers in that context.

The service level of a computer for any specified context is related to the number of useful operations per second (UOPS). This value is driven by several factors including the elegance of the program, memory size and

access time, and raw processing speed. Service level is also related to volume. Volume is less critical when a user does not need to carry the computer. It becomes a major determinant when a user must be ambulatory while using a computer.

Service level can be defined as

$$S = \left( \frac{UOPS}{V_H} \right) \left( \frac{F}{\text{person}} \right) \quad (2)$$

where,

$F = \min \{V_H, V_I\}$ ;

$V_H$ =volume of the hardware;

$$\left( \frac{UOPS}{V_H} \right) = \text{power density and is roughly constant.}$$

That is, the greater the UOPS, the larger the volume of the hardware.

$V_I$ =the constrained volume of user interface, that is, the largest hardware volume the user can employ to accomplish a specific computing task;

person=the number of individuals that must use the hardware.

For the majority of computing applications volume is irrelevant. Equations (1) and (2) mathematically describe this observation. In these contexts, the user is unconstrained by the volume of the hardware, and  $V_I$  is infinity making  $F$  equal to  $V_H$ . Volume hence has no influence on the service level ( $S$ ) and therefore no influence on the quantity ( $Q$ ) of computers demanded.

However, for users that desire to or must carry a computer around, the volume of the hardware becomes critical. Equations (1) and (2) mathematically describe this observation also. There exists for any rigid form factor a maximum volume ( $V_I$ ) beyond which the user cannot carry a computer. ( $F$ ) is then equal to ( $V_I$ ). Hence, increasing the power density is the only means to increase service level and therefore quantity demanded.

Now it is clear from equation (2) that if  $V_I$  can be increased,  $V_H$  can also be increased thus increasing the UOPS obtainable. This can be done without increasing power density. The flexible wearable computer directly increases  $V_I$  compared to rigid packaging schemes because it allows hardware to be shaped like articles of clothing allowing the more comfortably placement of larger volumes of hardware on various areas of the body. It obviates the need to carry the entire hardware in one or both hands. It also eliminates the uncomfortable nature of strapping a rigid device onto one aspect of the body. It also eliminates the need to make a variety of sizes such as the rigid curvilinear designs require. Further objects and advantages of the present invention are:

(a) To provide a flexible wearable computer that can be shaped into a limitless variety of shapes and sizes.

(b) To provide a flexible wearable computer that can accommodate a wide variety of human morphologies.

(c) To provide a flexible wearable computer that allows comfortable hands-free portability.

(d) To provide a flexible wearable computer that symmetrically distributes its volume and therefore evenly loads the spine.

(e) To provide a flexible wearable computer that eliminates flexi carpi ulnaris tendonitis.

(f) To provide a flexible wearable computer that is comfortable to wear while the human body is against a firm surface.

(g) To provide a flexible wearable computer that increases the compliance of field service users by allowing hands-free portability without sacrificing comfort.

(h) To provide a flexible wearable computer whereby the computer can be more comfortably carried and operated than an integrated computer of comparable processing power in a rigid rectilinear or curvilinear packages.

(i) To provide a flexible wearable computer that data transfer rates that are faster than wireless communication systems.

(j) To provide a flexible wearable computer that can more easily and comfortably be expanded than rigid package designs.

### DRAWING FIGURES

Other objects and advantages of the present invention and a full understanding thereof may be had by referring to the following detailed description and claims taken together with the accompanying illustrations. The illustrations are described below in which like parts are given like reference numerals in each of the drawings.

FIG. 1 is a perspective view of the prior art of a wearable portable computer system produced by Reddy Information Systems called Red.

FIG. 2 is a perspective view of the prior art of a wearable portable computer system by Takemasa of NEC Corporation.

FIG. 3 is a view of a user wearing the preferred embodiment of the flexible wearable computer system which by definition includes an input/output device.

FIG. 4 is a view of a user wearing the flexible wearable computer system with the outer sheath ghosted.

FIG. 5 is a perspective view of the preferred embodiment of the flexible wearable computer which by definition does not include the input/output device.

FIG. 6 is a perspective view of the flexible wearable computer showing the surface that contacts the body with the outer sheath partially removed.

FIG. 7 is a perspective view of the flexible wearable computer with the outer sheath completely removed.

FIG. 8 is a perspective exploded assembly view of microprocessor module.

FIG. 9 is an orthographic cross sectional view of the microprocessor module.

FIG. 10 is a perspective exploded assembly view of the RAM-I/O module.

FIG. 11 is a perspective exploded assembly view of the mass memory module.

FIG. 12 is a perspective exploded assembly view of the battery module.

FIG. 13 is an exploded assembly view of the bus termination module.

FIG. 14 is a perspective view of an alternative embodiment of the flexible wearable computer in the form of a vest.

FIG. 15 is a perspective view of the alternative embodiment in the form of a vest with the outer sheath ghosted.

FIG. 16 is a rear perspective view of the alternative embodiment in the form of a vest with the outer sheath ghosted.

### DRAWING REFERENCE NUMERALS

A	Reflection Technologies Private Eye wearable display
5 B	Reddy Information Systems DOS rigid rectilinear personal computer and RAM card reader
C	Padded harness
D	NEC Corporation's personal computer and CD-ROM reader
E	NEC Corporation's input device
10 F	NEC Corporation's output device
002a	Flexible circuit
002b	Flexible circuit
002c	Flexible circuit
002d	Flexible circuit
002e	Flexible circuit
002f	Flexible circuit
004	Tensile load strap
005a	Belt latch, male
005b	Belt latch, female
006	Foam sheath
010	Module recess
20 011a	Eyelet snap
011b	Eyelet snap
046	Seam surface
060	Portable input/output device
061	I/O bus
100	Bus termination module
112	But termination resistors
25 114	Bus termination printed circuit board
115	Bus termination module solder pins
116	Bus terminatin plated via holes
200	Microprocessor module
212	Microprocessor
212a	Microprocessor support components
214	Microprocessor printed circuit board
215	Microprocessor printed circuit board solder pins
216	Microprocessor plated via holes
217	Microprocessor module top shell
218	Microprocessor module bottom shell
219	Microprocessor module boss
35 219	Microprocessor module boss
220	Holes for microprocessor module assembly
222	Microprocessor module retention plate
223	Microprocessor module self tapping screw
300	RAM-I/O module
314	RAM-I/O printed circuit board
317	RAM-I/O module top shell
40 322	RAM-I/O module retention plate
323	RAM-I/O prot bezel
324	Random access memory chips
325	RAM-I/O Module orifice
326	Output device port
45 327	Input device port
328	Communications port
347	Input/output processor
347a	Support circuitry components
400	Mass memory module
412	Flash memory chip
414	Mass memory circuit board
417	Mass memory module top shell
500	Battery module
508	Battery bezel
514	Battery module printed circuit board
517	Battery module top shell
523	Battery module self tapping screw
55 530	Battery cartridge
531	Battery flature
533	Voltage regulation components

### DESCRIPTION OF PREFERRED EMBODIMENT

Referring now to the drawings, with particular attention to FIG. 3. The method of using the flexible wearable computer is straight forward. The user adjusts the flexible wearable computer to fit comfortably around the waist by varying the connection of male and female belt latches 005a, 005b to a flexible tensile load strap 004. An input/output device 060 is a pen based liquid crystal display device that has a clip allowing easy at-

tachment to a flexible compressive foam sheath 006 when not in use. The input/output device is connected to the processor and mass memory by an I/O bus 061.

FIG. 5 demonstrates the detail of the preferred embodiment. The computer is entirely encased in foam sheath 006 injection-molded out of antimicrobial micro-cellular polyurethane foam (such as Poron, available from Rogers Corporation), and varies in thickness from 0.140 inches thick to 0.250 inches thick, and is approximately 15.0 inches long. Flexible compressive foam sheath 006 necks (narrows) down at each end such that the opening in foam sheath 006 is the same width as tensile load strap 004. Tensile load strap 004 is a belt strap consist of woven aramid fibers (otherwise known as Kevlar, available from Dupont), but could consist of common nylon strapping or thin steel stranded cables. Tensile load strap 004 is approximately 2.0 inches  $\times$  0.02 inches  $\times$  47.0 inches. A port bezel 323 is adhered to foam sheath 006 with adhesive. It allows output device port 326, input device port 327, and communications port 328 to be exposed through foam sheath 006. A battery bezel 508 is adhered to foam sheath 006. Port bezel 323 and battery bezel 508 are all injection-molded out of ABS plastic.

FIG. 7 demonstrates the structure beneath foam sheath 006 of the preferred embodiment. Five different types of modules 100, 200, 300, 400, 500 are electrically connected to each other by polyimide (Kapton, available from Dupont) flexible circuits 002a, 002b, 002c, 002d, 002e, 002f. Each computer component module 100, 200, 300, 400, 500 is affixed to the tensile load strap 004. The two-part belt latch 005a and 005b is connected to each end of tensile load strap 004.

Referring now to FIG. 6, the flexible wearable computer is demonstrated with foam sheath 006 partially open revealing a molded-in module recess 010 which is approximately 0.125 inches deep. Each module 100, 200, 300, 400, 500 is seated in a separate module recess 010. FIG. 6 also reveals that foam sheath 006 is fastened to tensile load strap 004 by a pair of eyelet snaps 011a and 011b, located at both narrowed ends of foam sheath 006. Seam surface 046 which run the bottom length of foam sheath 006, are fastened to each other with adhesive.

#### Microprocessor Module

Referring to FIG. 8, the microprocessor module 200 is demonstrated. Microprocessor 212 and microprocessor support components 212a are of surface mount size, and are soldered to a microprocessor printed circuit board 214. The dimensions of microprocessor printed circuit board 214 are approximately 2.25 inches  $\times$  1.55 inches  $\times$  0.06 inches. At each of the long edges of microprocessor printed circuit board 214 are an array of microprocessor printed circuit board solder pins 215 which register with a corresponding array of plated via holes 216 on flexible circuit 002b. Solder pins 215 are soldered into plated via holes 16. Flexible circuit 002b and microprocessor printed circuit board 214 are sandwiched between a microprocessor module top shell 217 and microprocessor module bottom shell 218. Flexible circuit 002b is approximately 2.65 inches long  $\times$  2.00 inches wide  $\times$  0.006 inches thick. Microprocessor module bosses 219 extend from the microprocessor module top shell 217 through holes 220 in flexible circuit 002b and microprocessor printed-circuit board 214. The mechanical registration and therefore electrical connection

of plated via holes 216 with solder pins 215 is held true by bosses 219.

Microprocessor module top shell 217 and bottom shell 218 are shown in cross-section in FIG. 9 as having approximately a 0.10 inch radius edge detail curving away from flexible circuit 002b. This feature provides a limit on the radius of curvature experienced by flexible circuit 002b. Tensile load strap 004 is fastened against microprocessor module bottom shell 218 by microprocessor module retention plate 222 and self-tapping screws 223. Self tapping screws 223 fasten the entire assembly together by screwing into bosses 219 on microprocessor module top shell 217.

#### RAM-I/O and Mass Memory Modules

FIG. 10 demonstrates RAM-I/O module 300. It has the same basic construction as microprocessor module 200 except for two differences. First, instead of a microprocessor, random access memory chip 324 and input/output processor 347 and support circuitry components 347a, are soldered onto RAM-I/O circuit board 314. Second, output device port 326, input device port 327, and communications port 328 are electrically connected to RAM-I/O printed-circuit board 314, and extend through RAM-I/O module orifice 325 in RAM-I/O module top shell 317. Flexible circuit 002c is registered and fastened against RAM-I/O printed-circuit board 314 the same way as with the previously described microprocessor module 200. RAM-I/O module 300 is also connected to tensile load strap 004 in the same way as in previously described microprocessor module 200.

FIG. 11 demonstrates mass memory module 400. Multiple mass memory modules are shown in the preferred embodiment and are identical except for their software addresses, and have the same basic construction as microprocessor module 200 except for two differences. First, instead of a microprocessor, flash memory chip 412 (of which there are four) are soldered to printed-circuit board 414. Flexible circuits 002d, 002e are registered and fastened against printed-circuit board 414 the same way as in previously described modules 200. Mass memory modules 400 are also connected to tensile load strap 004 in the same way as in previously described module 200.

#### Battery and Bus Termination Modules

FIG. 12 demonstrates a battery module 500 containing a battery cartridge 530 held by a battery fixture 531, and a battery module top shell 517. Battery fixture 531 is fastened onto a printed-circuit board 514 with a screw 523. Voltage regulation components 533 are of surface mount size, and are soldered to printed-circuit board 514. Flexible circuit 002f is registered and fastened against printed-circuit board 514 the same way as in previously described module 200. Module top shell 517 and module bottom shell 518 are fastened the same way as in previously described module 200. Battery module 500 is also connected to tensile load strap 004 in the same way as in previously described module 200.

A bus termination module 100 is shown in FIG. 13. Bus termination resistors 112 are of surface mount size and soldered to a bus termination circuit board 114. Bus termination circuit board 114 measures approximately 2.00 inches  $\times$  0.30 inches  $\times$  0.06 inches. Bus termination circuit board 114 has an array of bus termination module solder pins 115 along one long edge which register with bus termination plated via holes 116 on flexible

circuit 002f. Flexible circuits 002a and 002f measure approximately 1.5 inches long×2.00 inches wide×0.006 inches. Bus termination module 100 is connected to tensile load strap 004 in the same way as in previously described module 200.

#### SUMMARY, RAMIFICATIONS, AND SCOPE

Accordingly, the reader will see that the flexible computer has the advantage of increasing the service level of portable computer hardware while also increasing the comfort of using the hardware. In addition, the flexible wearable computer has the advantages of:

- accommodating a wide variety of human morphologies;
- allowing hands-free carrying and operation;
- allowing the user to comfortably sit or lie while wearing the device;
- allowing the weight of the computer to be symmetrically distributed on the body;
- eliminating the muscle and tendon strain associated with carrying rigid rectilinear computers;
- increasing the compliance of field service personnel that must use a computer;
- allowing significantly larger amounts of secondary flash memory to be comfortably carried by the user;
- allowing expansion more easily and comfortably than rigid designs.

Although the description above contains many specificities, these should not be construed as limiting the scope of the invention, but merely providing illustration of some of the presently preferred embodiments of this invention. For example, the flexible tensile load bearing means could consist of individually twisted aramid fibers encased in the potting compound. The flexible tensile load bearing means could be fibers woven into cloth or even a homogeneous thin layer of material. The flexible signal relaying means could be glued or otherwise permanently attached to the tensile load bearing means.

Components and support circuitry need not be surface mount size and soldered. Components may be affixed with conductive epoxy, or assembled using chip on board technology.

The flexible signal relaying means could be discrete wires or discrete non metallic filaments. It could be produced with ink traces or any type of non-metallic, flexible conductive material. The computer could be implemented in fiber optics. The flexible circuit could be optical fiber filaments instead of metallic or non-metallic conductors. Also, the flexible signal relaying means could be an easily detachable and reattachable bus that is disposable.

Furthermore, the configuration of the flexible wearable computer need not be in a belt. The module and bus assembly can be fashioned in a variety of ways. FIG. 14 demonstrates an alternative embodiment of the flexible wearable computer in the shape of a vest for increasing the number of elements for computing. FIG. 15 shows the foam sheath of the vest removed revealing an increased number of modules. FIG. 16 demonstrates the bus arrangement to accommodate the increased number of modules thereby greatly expand the memory and processing capacity of the flexible wearable computer.

Thus the scope of the invention should be determined by the appended claims and their legal equivalents, rather than by the examples given.

I claim:

1. A flexible computer comprising, in combination, elements for computing comprising a plurality of mechanically disintegrated but functionally intact components of an otherwise integrated computer:
  - a flexible signal relaying means operably connecting said elements for computing;
  - a flexible nonstretchable wearable member;
  - a mounting means for mounting said elements for computing and said flexible signal relaying means on said wearable member;
  - a protective covering means mechanically connected to said flexible non-stretchable wearable member for enclosing said elements for computing and said flexible signal relaying means.
2. The flexible computer of claim 1 wherein said flexible signal relaying means can be easily detached from and reattached to the computing elements and is therefore replaceable and disposable.
3. The flexible computer of claim 1 wherein said mounting means includes
  - a module bottom shell;
  - a module top shell;
  - a circuit board member for mounting at least one of said computing elements thereon and positioned between the bottom shell and the top shell, said flexible nonstretchable wearable member positioned on the opposite side of the bottom shell from the position of said circuit board member;
  - a retention plate positioned on the opposite side of the wearable member from the bottom shell; a clamping means for mechanically connecting the top shell, the bottom shell, said circuit board member, the wearable member, and said retention plate.
4. The flexible computer of claim 3 wherein said protective covering is an antimicrobial microcellular polyurethane foam sheath.
5. The flexible computer of claim 3 wherein said flexible nonstretchable wearable member consists of woven aramid fibers.
6. The flexible computer of claim 3 wherein the computing elements includes flash memory as a nonvolatile data storage means.
7. The flexible computer of claim 3 in the form of a belt.
8. The flexible computer of claim 3 in the form of a vest.
9. The flexible computer of claim 1 wherein the computing elements includes flash memory as a nonvolatile data storage means.
10. A flexible computer in the form of a wearable article comprising, in combination, elements for computing comprising a microprocessor, an input/output controller, a plurality of data storage means, a power supply, and a plurality of computing components;
  - a plurality of flexible signal relaying means operably connected with the computing elements;
  - a flexible tensile load bearing means mechanically connected with the computing elements and said flexible signal relaying means for limiting tensile loads;
  - a flexible compressive load bearing means connected to with the computing elements, said flexible signal relaying means, and said tensile load bearing means for limiting compressive loads;
  - a curvature radius limiting means mechanically connecting the computing elements and said flexible signal relaying means, and said tensile load bearing

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means for limiting the curvature radius experienced.

11. The flexible computer of claim 10 wherein said curvature radius limiting means comprises:

- a module bottom shell;
- a module top shell;

a circuit board member for mounting at least one of said computing elements thereon and positioned between the bottom shell and the top shell, said tensile load bearing means positioned on the opposite side of the bottom shell from the position of said circuit board member;

a retention plate positioned on the opposite side of said tensile load bearing means from the bottom shell;

a clamping means for mechanically connecting the top shell, the bottom shell, said circuit board member, said tensile load bearing means, and said retention plate.

12. The flexible computer of claim 11 wherein the computing elements includes flash memory as a nonvolatile data storage means.

13. The flexible computer of claim 11 wherein said tensile load bearing means consists of woven aramid fibers.

14. The flexible computer of claim 11 wherein said protective covering is a antimicrobial microcellular polyurethane foam sheath.

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15. The flexible computer of claim 10 wherein the plurality of flexible signal relaying means can be easily detached from and reattached to the computing elements and is therefore replaceable and disposable.

16. The flexible computer of claim 10 wherein the computing elements includes flash memory as a nonvolatile data storage means.

17. A method of computing comprising the steps of:

a. mechanically disintegrating functionally intact elements for computing with an otherwise integrated computer;

b. flexibly connecting said elements for computing with a flexible signal relaying means on a flexible non-stretchable wearable member;

c. enclosing said elements, said relaying means and said wearable member within a protective covering;

d. wearing said wearable member on the person; and

e. computing with said elements and said relaying means worn on the person.

18. The method of claim 17 wherein said connecting step includes connecting with an expansion bus.

19. The method of claim 18 including detaching and replacing said expansion bus with a replacement expansion bus.

20. The method of claim 17 including connecting as one of said elements a flash memory as a non-volatile data storage means.

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